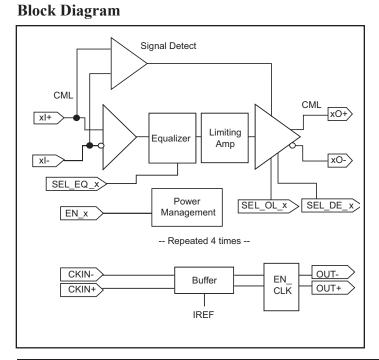


# 3.2Gbps, 2-Port, SATAi/m, Serial Re-Driver

#### **Features**

- Supports data rates up to 3.2Gbps on each lane
- Adjustable Transmiter De-Emphasis & Amplitude
- Adjustable Receiver Equalization
- Spectrum Reference Clock Buffer Output
- Optimized for SATAi/m applications
- Input signal level detection & output squelch on all channels
- 100-Ohm Differential CML I/O's
- Low Power (100mW per Channel)
- Standby Mode Power Down State
- V<sub>DD</sub> Operating Range: 1.8V +/-0.1V
- Packaging (Pb-free & Green):48-contact TQFN



### **Description**

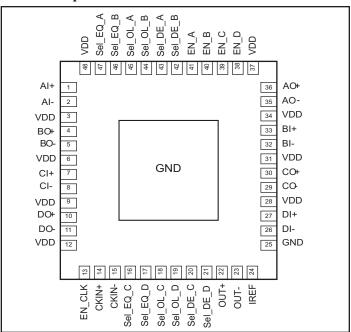
Pericom Semiconductor's PI2EQX3232B is a low power, signal Re-Driver. The device provides programmable equalization, amplification, and de-emphasis, to optimize performance over a variety of physical mediums by reducing Inter-Symbol Interference (ISI). PI2EQX3232B supports four 100-Ohm Differential CML data I/O's between the Protocol ASIC to a switch fabric, across a backplane, or to extend the signals across other distant data pathways on the user's platform.

The integrated equalization circuitry provides flexibility with signal integrity of the signal before the Re-Driver. Whereas the integrated de-emphasis circuitry provides flexibility with signal integrity of the signal after the Re-Driver.

A low-level input signal detection and output squelch function is provided for all four channels. Each channel operates fully independantly. When a channel is enabled (EN\_x=1) and operating, that channels input signal level (on xI+/-) determines whether the output is enabled. If the input level of the channel falls below the active threshold level (Vth-) then the output driver switches off, and the pin is pulled to VDD via a high impedance resistor. If the input level of the channel falls below the active threshold level (Vth-) then the outputs are driven to the common mode voltage.

In addition to providing signal re-conditioning, Pericom's PI2EQX3232B also provides power management Stand-by mode operated by an Enable pin.

### **Pin Description**





**Pin Description** 

Pin #	Pin Name	I/O	Description	
1	AI+	I	Positive CML Input Channel A with internal 50Ω pull down	
2	AI-	I	Negative CML Input Channel A with internal 50Ω pull down	
36	AO+	О	Positive CML Output Channel A internal $50\Omega$ pull up to VDD during normal operation and $2k\Omega$ when EN_A=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub>	
35	AO-	О	Negative CML Output Channel A with internal $50\Omega$ pull up to VDD during normal operation and $2k\Omega$ when EN_A=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub>	
33	BI+	I	Positive CML Input Channel B with internal $50\Omega$ pull down	
32	BI-	I	Negative CML Input Channel B with internal 50Ω pull down	
4	BO+	О	Positive CML Output Channel B with internal 50 $\Omega$ pull up to VDD during normal operation and 2k $\Omega$ when EN_B=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub>	
5	ВО-	О	Negative CML Output Channel B with internal $50\Omega$ pull up to VDD during normal operation and $2k\Omega$ when EN_B=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub>	
7	CI+	I	Positive CML Input Channel C with internal 50Ω pull down	
8	CI-	I	Negative CML Input Channel C with internal 50Ω pull down	
14	CKIN+	I	Differential Input Reference Clock	
15	CKIN-	I	•	
30	CO+	0	Positive CML Output Channel C with internal 50 $\Omega$ pull up to VDD during norma operation and 2k $\Omega$ when EN_C=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub> .	
29	CO-	О	Negative CML Output Channel C with internal $50\Omega$ pull up to VDD during nor operation and $2k\Omega$ when EN_C=0. Drives to output common mode voltage whe input is $<$ V <sub>TH</sub> .	
27	DI+	I	Positive CML Input Channel D with internal 50Ω pull down	
26	DI-	I	Negative CML Input Channel D with internal 50Ω pull down	
10	DO+	0	Positive CML Output Channel D with internal $50\Omega$ pull up to VDD during normal operation and $2k\Omega$ when EN_D=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub> .	
11	DO-	О	Negative CML Output Channel C with internal $50\Omega$ pull up to VDD during normal operation and $2k\Omega$ when EN_D=0. Drives to output common mode voltage when input is $<$ V <sub>TH</sub>	
1, 40, 39, 38	EN_ [A,B,C,D]	I	Active HIGH LVCMOS signal input pins, when HIGH, it enables the CML output. When LOW, it disables the CML output (x0+, x0-) to HI-z state. Both x0+ & x0- ou puts will be pulled up to $V_{DD}$ by internal $2k\Omega$ resistor.	
13	EN_CLK	I	Active HIGH LVCMOS signal input pin. When HIGH, it enables the OUTx+/OUT: outputs. When LOW, it disables these outputs, with $50\Omega$ to ground termination.	
5, Center Pad	GND	PWR	Supply Ground	
24	IREF	О	External $475\Omega$ resistor connection to set the differential output current	
22 23	OUT0+ OUT1-	0 0	Differential Reference Clock Output	
47	SEL_EQ_A	I		
46	SEL_EQ_B	I	Selection pins for equalizer (see Amplifier Configuration Table)	
16	SEL_EQ_C	I	$m/50$ k $\Omega$ internal pull up	
17	SEL_EQ_D	I	_	



### Pin Description (Continued)

Pin #	Pin Name	I/O	Description	
45	SEL_OL_A	I		
44	SEL_OL_B	I	Selection pins for amplifier (see Amplifier Configuration Table)	
18	SEL_OL_C	I	$w/50k\Omega$ internal pull up	
19	SEL_OL_D	I		
43	SEL_DE_A	I		
42	SEL_DE_B	I	Selection pins for De-Emphasis (See De-Emphasis Configuration Table)	
20	SEL_DE_C	I	$w/50k\Omega$ internal pull up	
21	SEL_DE_D	I		
3,6,9,12,28, 31,34,37,38	$V_{\mathrm{DD}}$	PWR	1.8V Supply Voltage	

# **Output Swing Control**

SEL3_[A:D]	Swing
0	1x
1	1.2x

# **Output De-emphasis Adjustment**

SEL5_[A:D]	De-emphasis		
0	0dB		
1	-3.5dB		

### **Equalizer Selection**

SEL0_[A:D]	Compliance Channel
0	[0:3.5dB] @ 1.6 GHz
1	[0:7.5dB] @ 1.6 GHz

# **Maximum Ratings**

(Above which useful life may be impaired. For user guidelines, not tested.)

Storage Temperature	65°C to +150°C
Supply Voltage to Ground Potential	0.5V to +2.5V
DC SIG Voltage	0.5V to V <sub>DD</sub> +0.5V
Current Output	25mA to +25mA
Power Dissipation Continous	800mW
Operating Temperature	0 to +70°C

#### Note:

Stresses greater than those listed under MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.



# **AC/DC Electrical Characteristics** ( $V_{DD} = 1.8 \pm 0.1 V$ )

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Da	Supply Power	EN = LVCMOS Low			0.1	w
Ps		EN = LVCMOS High			0.6	W
	Latency	From input to output		2.0		ns
CML Receive	·Input					
$RL_{RX}$	Return Loss	50 MHz to 1.25 GHz		12		dB
V <sub>RX-DIFFP-P</sub>	Differential Input Peak-to- peak Voltage		0.200			V
V <sub>RX-CM-ACP</sub>	AC Peak Common Mode Input Voltage				150	mV
V <sub>TH</sub> -	Signal Detect Threshold	$E_{N_{\perp}X} = High$	50		200	mVp-p
Z <sub>RX-DIFF-DC</sub>	DC Differential Input Impedance		80	100	120	Ω
Z <sub>RX-DC</sub>	DC Input Impedance		40	50	60	
Equalization						
Inc	Residual Jitter <sup>(1,2)</sup>	Total Jitter			0.3	Illn n
$J_{RS}$	Kesiduai Jillel	Deterministic jitter			0.2	- Ulp-p
$J_{RM}$	Random Jitter <sup>(1,2)</sup>			1.5		psrms

#### Notes

- 1. K28.7 pattern is applied differentially at point A as shown in Figure 1.
- 2. Total jitter does not include the signal source jitter. Total jitter (TJ) = (14.1 × RJ + DJ) where RJ is random RMS jitter and DJ is maximum deterministic jitter. Signal source is a K28.5 ± pattern (00 1111 1010 11 0000 0101) for the deterministic jitter test and K28.7 (0011111000) or equivalent for random jitter test. Residual jitter is that which remains after equalizing media-induced losses of the environment of Figure 1 or its equivalent. The deterministic jitter at point B must be from media-induced loss, and not from clock source modulation. Jitter is measured at 0V at point C of Figure 1.

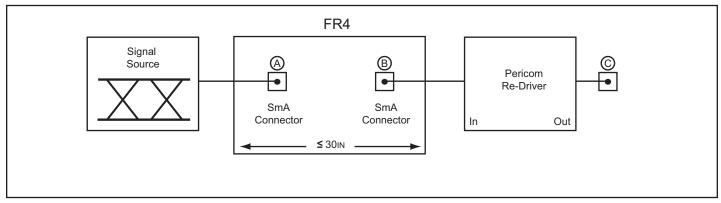


Figure 1. Test Condition Referenced in the Electrical Characteristic Table



# **AC/DC Electrical Characteristics (**TA = 0 to 70°C)

Symbol	Parameter	Cone	ditions	Min.	Тур.	Max.	Units
CML Transmitt	er Output (100 $\Omega$ differential)						
17	Output Voltage Swing;   V <sub>TX-D+</sub>	Differential	Swing = 1.0x	200		375	
$V_{DIFFP}$	- V <sub>TX-D-</sub>	Swing	Swing = $1.2x$	250		450	mVp-p
	Differential Peak-to-peak Ouput	Swing = $1.0x$		400		750	
V <sub>TX-DIFFP-P</sub>	Voltage; $V_{TX-DIFFP-P} = 2 *   V_{TX-D+} - V_{TX-D-}  $	Swing = 1.2x		500		900	mV
t <sub>F</sub> , t <sub>R</sub>	Transition Time	20% to 80% <sup>(1)</sup>				150	ps
Z <sub>OUT</sub>	Output resistance	Single ended		40	50	60	Ω
Z <sub>TX-DIFF-DC</sub>	DC Differential TX Impedance			80	100	120	Ω
$C_{TX}$	AC Coupling Capacitor			75		200	nF
LVCMOS Conti	rol Pins						
V <sub>IH</sub>	Input High Voltage			0.65 × V <sub>DD</sub>		$V_{ m DD}$	V
V <sub>IL</sub>	Input Low Voltage				$0.35 \times V_{DD}$	]	
I <sub>IH</sub>	Input High Current Input Low Current		250				
$I_{\mathrm{IL}}$						500	μA

### Note:

- 1. Using K28.7 (0011111000) pattern)
- 2. When 1.0x swing selected
- 3. When 1.2x swing selected



# AC Switching Characteristics for Clock Buffer $(V_{DD} = 1.8 \pm 0.1 V)^{(3)}$

Symbol	Parameters		Max.	Units	Notes
T <sub>rise</sub> / T <sub>fall</sub>	Rise and Fall Time (measured between 0.175V to 0.525V) (1)		525		1
$\Delta T_{rise}$ / $\Delta T_{fall}$	Rise and Fall Time Variation		75	ps	1
$V_{\mathrm{HIGH}}$	Voltage High including overshoot	660	900		1
$V_{ m LOW}$	Voltage Low including undershoot	-150		<b>V</b> /	1
V <sub>CROSS</sub>	Absolute crossing point voltages	-200	550	mV	1
$\Delta V_{CROSS}$	Total Variation of Vcross over all edges	200	250		1
$T_{DC}$	Duty Cycle (input duty cycle = 50%) (2)	45	55	%	2

#### **Notes:**

- 1. Measurement taken from Single Ended waveform.
- 2. Measurement taken from Differential waveform.
- 3. Test configuration is  $R_S = 33.2\Omega$ ,  $Rp = 49.9\Omega$ , and 2pF.

# **Configuration Test Load Board Termination**

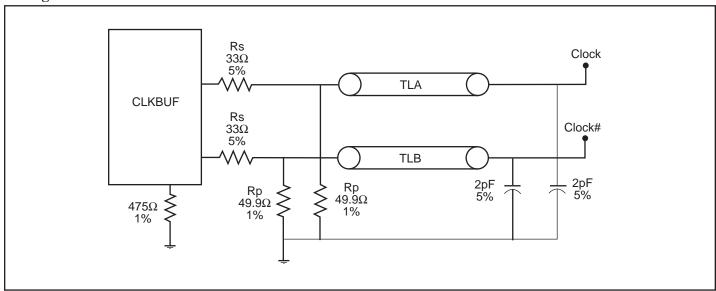


Figure 2. Configuration test load board termination

#### Note:

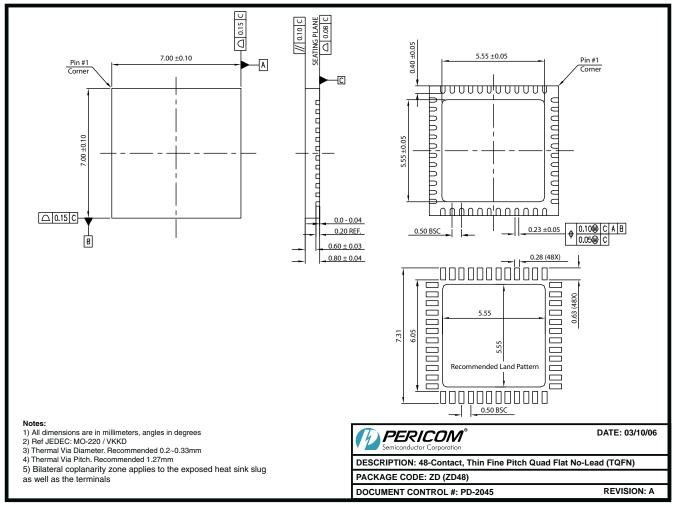
• TLA and TLB are 3" transmission lines.

PS8889D

10/03/07



# Packaging Mechanical: 48-Contact TQFN (ZD48)



06-0252

### **Ordering Information**

Ordering Number	Package Code	Package Description		
PI2EQX3232BZDE	ZD	Pb-free & Green 48-Contact TQFN		

#### **Notes:**

- Thermal characteristics can be found on the company web site at www.pericom.com/packaging/
- E = Pb-free and Green
- X suffix = Tape/Reel

Pericom Semiconductor Corporation • 1-800-435-2336 • www.pericom.com